

AD648—SPECIFICATIONS (@ + 25°C and $V_S = \pm 15$ V dc, unless otherwise noted.)

Model	AD648J/A/S			AD648K/B/T			Unit
	Min	Typ	Max	Min	Typ	Max	
INPUT OFFSET VOLTAGE ¹							
Initial Offset		0.75	2.0		0.3	1.0	mV
T _{MIN} to T _{MAX}			3.0/3.0/3.0			1.5/1.5/2.0	μV/°C
vs. Temperature			20			10	dB
vs. Supply	80			86			dB
vs. Supply, T _{MIN} to T _{MAX}	76/76/76			80			dB
Long-Term Offset Stability		15			15		μV/month
INPUT BIAS CURREN							
Either Input, ² V _{CM} = 0		5	20		3	10	pA
Either Input ² at T _{MAX} , V _{CM} = 0			0.45/1.3/20			0.25/0.65/10	nA
Max Input Bias Current Over							
Common-Mode Voltage Range			30			15	pA
Offset Current, V _{CM} = 0		5	10		2	5	pA
Offset Current at T _{MAX}			0.25/0.7/10			0.15/0.35/5	nA
MATCHING CHARACTERISTICS ³							
Input Offset Voltage		1.0	2.0		0.5	1.0	mV
Input Offset Voltage T _{MIN} to T _{MAX}			3.0/3.0/3.0			1.5/1.5/2.0	mV
Input Offset Voltage vs. Temperature		8			5		μV/°C
Input Bias Current			10			5	pA
Crosstalk		-120			-120		dB
INPUT IMPEDANCE							
Differential		1 × 10 ¹² 3			1 × 10 ¹² 3		Ω pF
Common Mode		3 × 10 ¹² 3			3 × 10 ¹² 3		Ω pF
INPUT VOLTAGE RANGE							
Differential ⁴		±20			±20		V
Common Mode	±11	±12		±11	±12		V
Common-Mode Rejection							
V _{CM} = ±10 V	76			82			dB
T _{MIN} to T _{MAX}	76/76/76			82			dB
V _{CM} = ±11 V	70			76			dB
T _{MIN} to T _{MAX}	70/70/70			76			dB
INPUT VOLTAGE NOISE							
Voltage 0.1 Hz to 10 Hz		2			2		μV p-p
f = 10 Hz		80			80		nV/√Hz
f = 100 Hz		40			40		nV/√Hz
f = 1 kHz		30			30		nV/√Hz
f = 10 kHz		30			30		nV/√Hz
INPUT CURRENT NOISE							
f = 1 kHz		1.8			1.8		fA/√Hz
FREQUENCY RESPONSE							
Unity Gain, Small Signal	0.8	1.0		0.8	1.0		MHz
Full Power Response		30			30		kHz
Slew Rate, Unity Gain	1.0	1.8		1.0	1.8		V/μs
Settling Time to ±0.01%		8			8		μs
OPEN-LOOP GAIN							
V _O = ±10 V, R _L ≥ 10 kΩ	300	1000		300	1000		V/mV
T _{MIN} to T _{MAX} , R _L ≥ 10 kΩ	300/300/300	700		300	700		V/mV
V _O = ±10 V, R _L ≥ 5 kΩ	150	500		150	500		V/mV
T _{MIN} to T _{MAX} , R _L ≥ 5 kΩ	150/150/150	300		150	300		V/mV

SPECIFICATIONS (Continued)

Model	AD648J/A/S			AD648K/B/T			Unit
	Min	Typ	Max	Min	Typ	Max	
OUTPUT CHARACTERISTICS							
Voltage @ $R_L \geq 10\text{ k}\Omega$, T_{MIN} to T_{MAX}	$\pm 12/\pm 12/\pm 12$			± 12			V
Voltage @ $R_L \geq 5\text{ k}\Omega$, T_{MIN} to T_{MAX}	$\pm 11/\pm 11/\pm 11$			± 11			V
Short Circuit Current	15			15			mA
POWER SUPPLY							
Rated Performance	± 15			± 15			V
Operating Range	± 4.5	± 18		± 4.5	± 18		V
Quiescent Current (Both Amplifiers)	340			340			μA
TEMPERATURE RANGE							
Operating, Rated Performance							
Commercial (0°C to 70°C)	AD648J			AD648K			
Industrial (−40°C to +85°C)	AD648A			AD648B			
Military (−55°C to +125°C)	AD648S			AD648T			
PACKAGE OPTIONS							
SOIC (R-8)	AD648JR			AD648KR			
Plastic (N-8)	AD648JN			AD648KN			
CERDIP (Q-8)	AD648AQ ⁵ , AD648SQ ⁵			AD648BQ ⁵ , AD648TQ/883B ⁵			
Tape and Reel	AD648JR-REEL, AD648JR-REEL7			AD648KR-REEL, AD648KR-REEL7			

NOTES

¹Input Offset Voltage specifications are guaranteed after five minutes of operation at $T_A = 25^\circ\text{C}$.

²Bias Current specifications are guaranteed maximum at either input after five minutes of operation at $T_A = 25^\circ\text{C}$. For higher temperature, the current doubles every 10°C .

³Matching is defined as the difference between parameters of the two amplifiers.

⁴Defined as voltages between inputs, such that neither exceeds $\pm 10\text{ V}$ from ground.

⁵Not for new design. Obsolete April 2002.

Specifications subject to change without notice.

AD648

ABSOLUTE MAXIMUM RATINGS¹

Supply Voltage	±18 V
Internal Power Dissipation ²	500 mW
Input Voltage ³	±18 V
Output Short Circuit Duration	Indefinite
Differential Input Voltage	+V _S and -V _S
Storage Temperature Range (Q, H)	-65°C to +150°C
(N, R)	-65°C to +125°C
Operating Temperature Range	
AD648J/K	0°C to 70°C
AD648A/B	-40°C to +85°C
AD648S/T	-55°C to +125°C
Lead Temperature Range (Soldering 60 sec)	300°C

NOTES

¹Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

²Thermal Characteristics:

8-Pin Plastic Package: $\theta_{JA} = 165^{\circ}\text{C/Watt}$
8-Pin Cerdip Package: $\theta_{JC} = 22^{\circ}\text{C/Watt}$; $\theta_{JA} = 110^{\circ}\text{C/Watt}$
8-Pin SOIC Package: $\theta_{JC} = 42^{\circ}\text{C/Watt}$; $\theta_{JA} = 160^{\circ}\text{C/Watt}$

³For supply voltages less than ±18 V, the absolute maximum input voltage is equal to the supply voltage.

CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD648 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high-energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



Typical Performance Characteristics—AD648

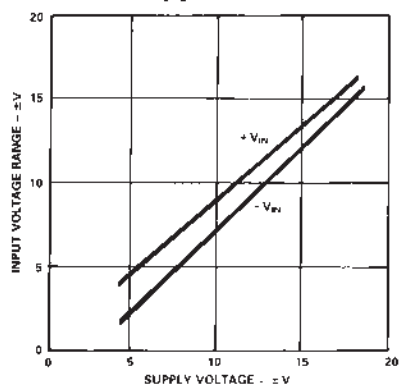


Figure 1. Input Voltage Range vs. Supply Voltage

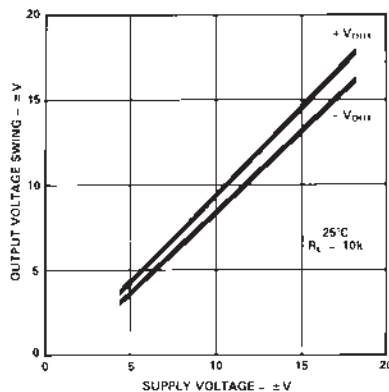


Figure 2. Output Voltage Swing vs. Supply Voltage

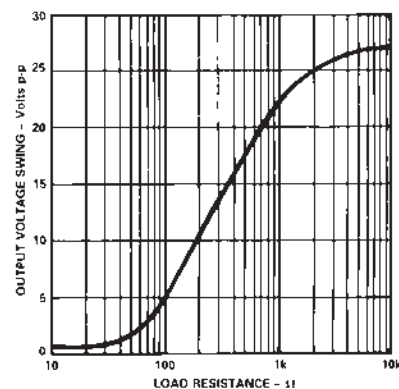


Figure 3. Output Voltage Swing vs. Load Resistance

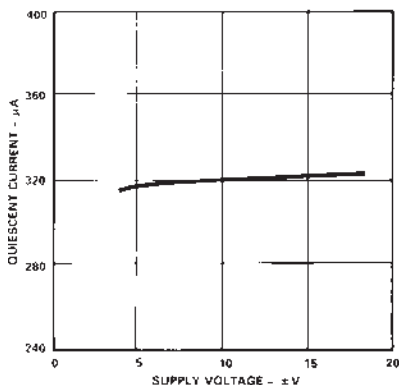


Figure 4. Quiescent Current vs. Supply Voltage

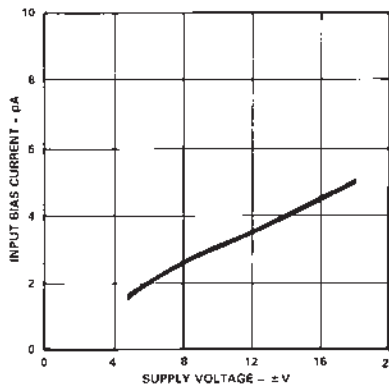


Figure 5. Input Bias Current vs. Supply Voltage

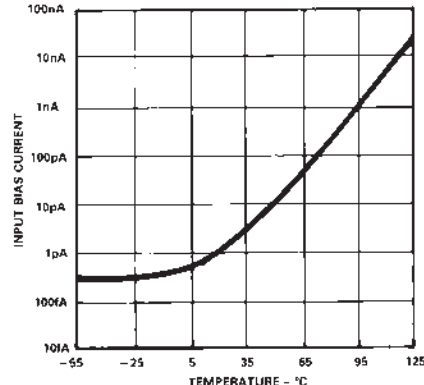


Figure 6. Input Bias Current vs. Temperature

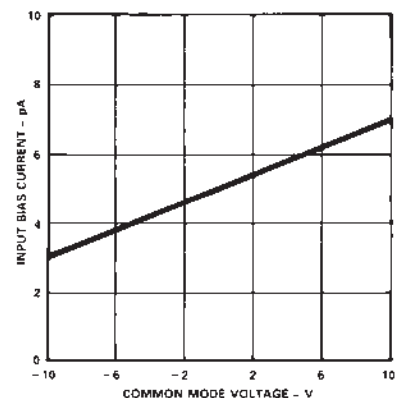


Figure 7. Input Bias Current vs. Common-Mode Voltage

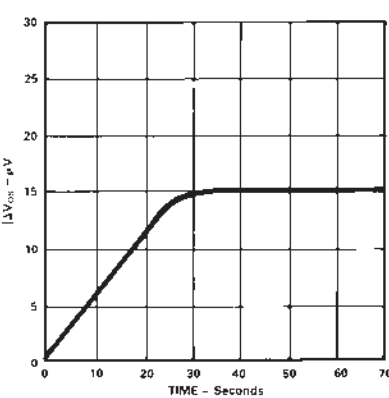


Figure 8. Change in Offset Voltage vs. Warm-Up Time

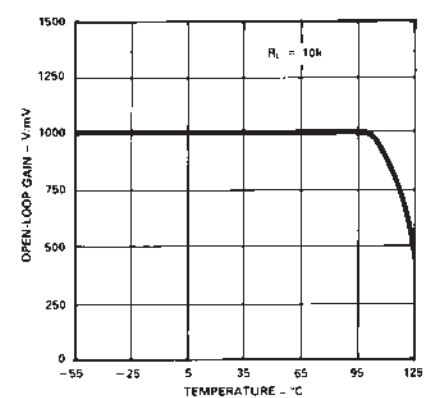


Figure 9. Open-Loop Gain vs. Temperature

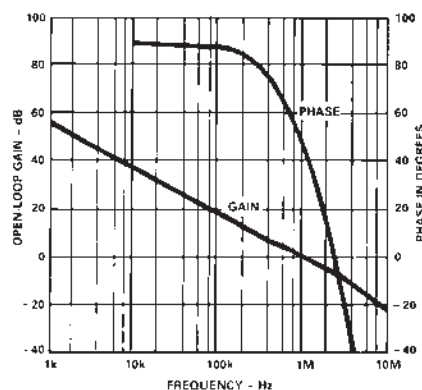


Figure 10. Open-Loop Frequency Response

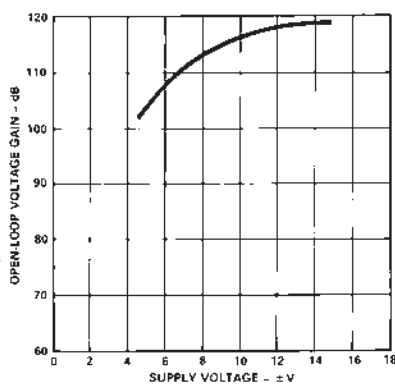


Figure 11. Open-Loop Voltage Gain vs. Supply Voltage

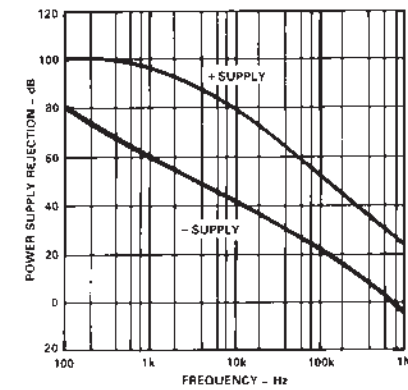


Figure 12. PSRR vs. Frequency

AD648

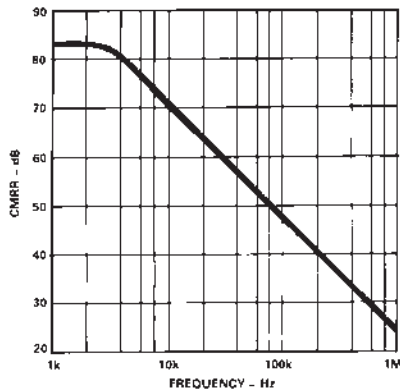


Figure 13. CMRR vs. Frequency

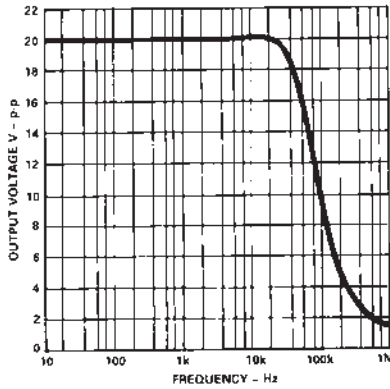


Figure 14. Large Signal Frequency Response

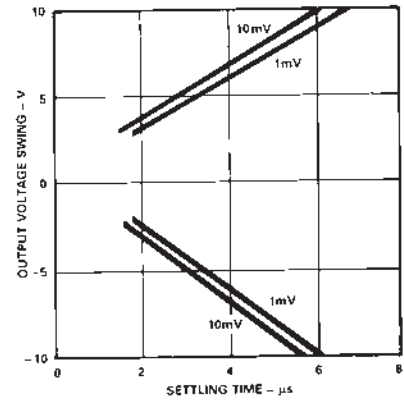


Figure 15. Output Swing and Error Voltage vs. Output Settling Time

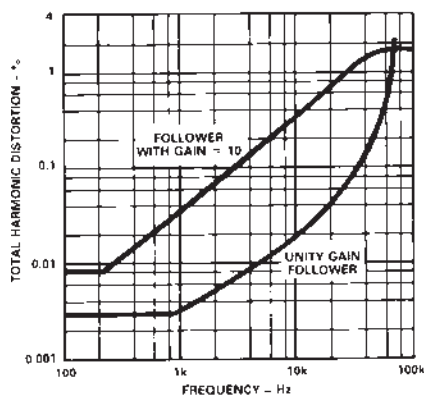


Figure 16. Total Harmonic Distortion vs. Frequency

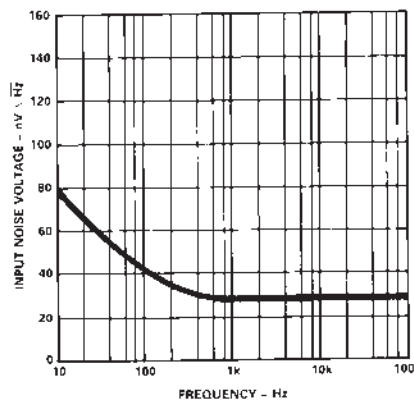


Figure 17. Input Noise Voltage Spectral Density

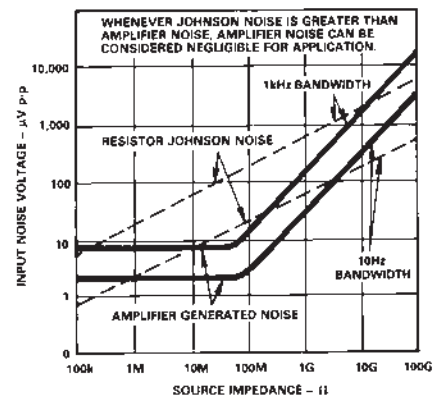


Figure 18. Total Noise vs. Source Impedance

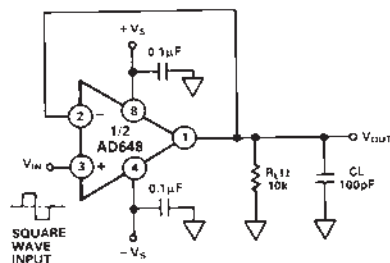


Figure 19a. Unity Gain Follower

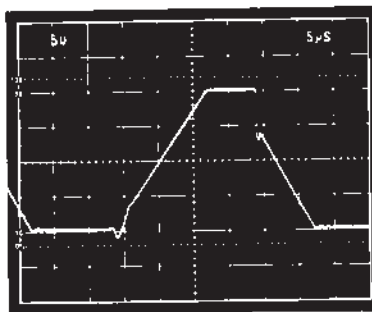


Figure 19b. Unity Gain Follower Pulse Response (Large Signal)

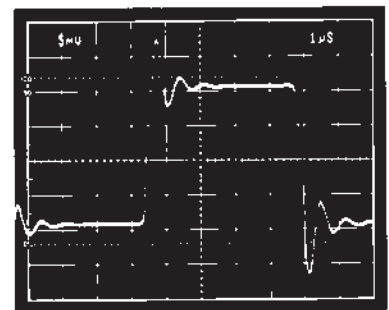


Figure 19c. Unity Gain Follower Pulse Response (Small Signal)

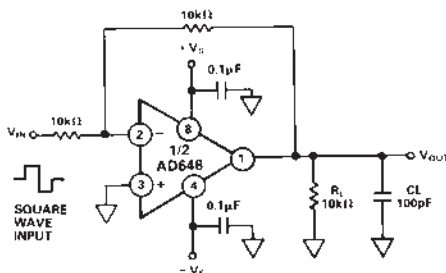


Figure 20a. Unity Gain Inverter

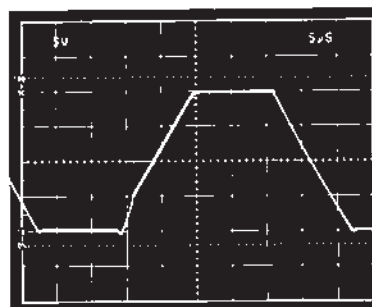


Figure 20b. Unity Gain Inverter Pulse Response (Large Signal)

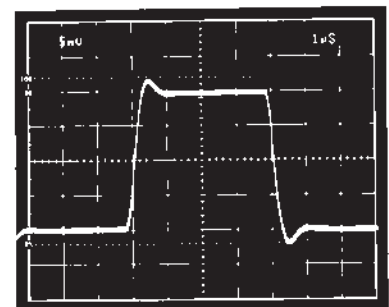


Figure 20c. Unity Gain Inverter Pulse Response (Small Signal)

APPLICATION NOTES

The AD648 is a pair of JFET-input op amps with a guaranteed maximum I_B of less than 10 pA, and offset and drift laser-trimmed to 1.0 mV and 10 $\mu\text{V}/^\circ\text{C}$, respectively (AD648B). AC specs include 1 MHz bandwidth, 1.8 V/ μs typical slew rate and 8 μs settling time for a 20 V step to $\pm 0.01\%$ —all at a supply current less than 400 μA . To capitalize on the device's performance, a number of error sources should be considered.

The minimal power drain and low offset drift of the AD648 reduce self-heating or “warm-up” effects on input offset voltage, making the AD648 ideal for on/off battery powered applications. The power dissipation due to the AD648's 400 μA supply current has a negligible effect on input current, but heavy output loading will raise the chip temperature. Since a JFET's input current doubles for every 10°C rise in chip temperature, this can be a noticeable effect.

The amplifier is designed to be functional with power supply voltages as low as ± 4.5 V. It will exhibit a higher input offset voltage than at the rated supply voltage of ± 15 V, due to power supply rejection effects. Common-mode range extends from 3 V more positive than the negative supply to 1 V more negative than the positive supply. Designed to cleanly drive up to 10 k Ω and 100 pF loads, the AD648 will drive a 2 k Ω load with reduced open-loop gain.

Figure 21 shows the recommended crosstalk test circuit. A typical value for crosstalk is -120 dB at 1 kHz.

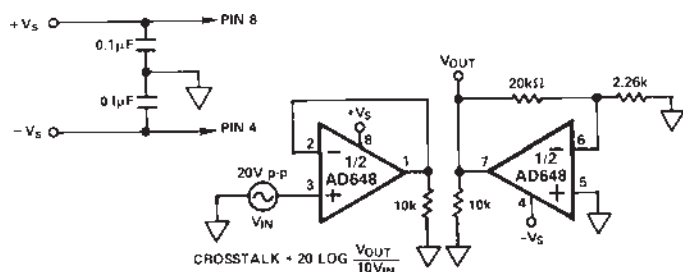


Figure 21. Crosstalk Test Circuit

LAYOUT

To take full advantage of the AD648's 10 pA max input current, parasitic leakages must be kept below an acceptable level. The practical limit of the resistance of epoxy or phenolic circuit board material is between $1 \times 10^{12} \Omega$ and $3 \times 10^{12} \Omega$. This can result in an additional leakage of 5 pA between an input of 0 V and a -15 V supply line. Teflon or a similar low leakage material (with a resistance exceeding $10^{17} \Omega$) should be used to isolate high impedance input lines from adjacent lines carrying high voltages. The insulator should be kept clean, since contaminants will degrade the surface resistance.

A metal guard completely surrounding the high impedance nodes and driven by a voltage near the common-mode input potential can also be used to reduce some parasitic leakages. The guarding pattern in Figure 22 will reduce parasitic leakage due to finite board surface resistance; but it will not compensate for a low volume resistivity board.

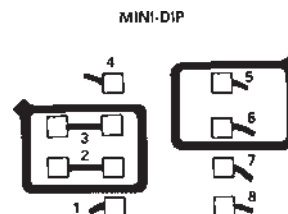


Figure 22. Board Layout for Guarding Inputs

INPUT PROTECTION

The AD648 is guaranteed to withstand input voltages equal to the power supply potential. Exceeding the negative supply voltage on either input will forward bias the substrate junction of the chip. The induced current may destroy the amplifier due to excess heat.

Input protection is required in applications such as a flame detector in a gas chromatograph, where a very high potential may be applied to the input terminals during a sensor fault condition. Figures 23a and 23b show simple current limiting schemes that can be used. R_{PROTECT} should be chosen such that the maximum overload current is 1.0 mA (for example 100 k Ω for a 100 V overload).

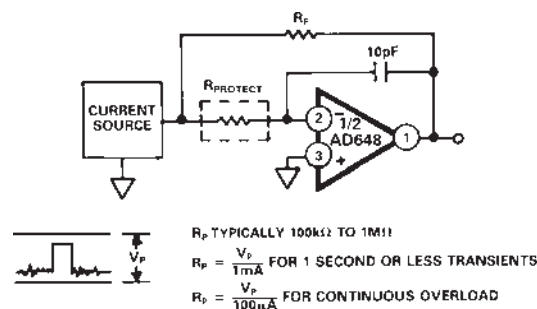


Figure 23a. Input Protection of I-to-V Converter

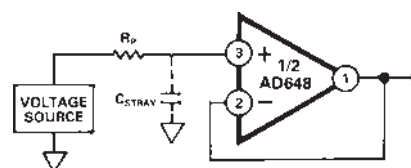


Figure 23b. Voltage Follower Input Protection Method

Figure 23b shows the recommended method for protecting a voltage follower from excessive currents due to high voltage breakdown. The protection resistor, R_P , limits the input current. A nominal value of 100 k Ω will limit the input current to less than 1 mA with a 100 volt input voltage applied.

The stray capacitance between the summing junction and ground will produce a high-frequency roll-off with a corner frequency equal to:

$$f_{\text{corner}} = \frac{1}{2\pi R_P C_{\text{stray}}}$$

Accordingly, a 100 k Ω value for R_P with a 3 pF C_{stray} will cause a 3 dB corner frequency to occur at 531 kHz.

Figure 23c shows a diode clamp protection scheme for an I-to-V converter using low leakage diodes. Because the diodes are connected to the op amp’s summing junction, which is a virtual ground, their leakage contribution is minimal.

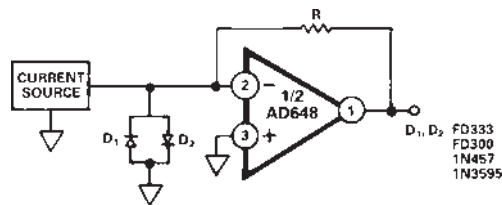


Figure 23c. I-to-V Converter with Diode Input Protection

Exceeding the negative common-mode range on either input terminal causes a phase reversal at the output, forcing the amplifier output to the corresponding high or low state. Exceeding the negative common mode on both inputs simultaneously forces the output high. Exceeding the positive common-mode range on a single input does not cause a phase reversal; but if both inputs exceed the limit, the output will be forced high. In all cases, normal amplifier operation is resumed when input voltages are brought back within the common-mode range.

D/A CONVERTER BIPOLAR OUTPUT BUFFER

The circuit in Figure 24 provides 4 quadrant multiplication with a resolution of 12 bits. The AD648 is used to convert the AD7545

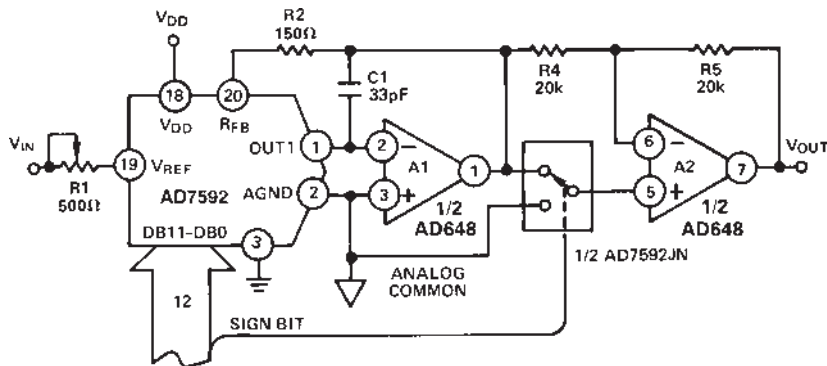


Figure 24. 12-Bit Plus Sign Magnitude D/A Converter

SIGN BIT	BINARY NUMBER IN DAC REGISTER	ANALOG OUTPUT
0	1111 1111 1111	+VIN × (4095/4096)
0	0000 0000 0000	0 V
1	0000 0000 0000	0 V
1	1111 1111 1111	-VIN × (4095/4096)

NOTE
SIGN BIT AT "0" CONNECTS THE NONINVERTING INPUT OF A2 TO ANALOG COMMON

CMOS DAC’s output current to a voltage and provides the necessary level shifting to achieve a bipolar voltage output. The circuit operates with a 12-bit plus sign input code. The transfer function is shown in Figure 25.

The AD7592 is a fully protected dual CMOS SPDT switch with data latches. R4 and R5 should match to within 0.01% to maintain the accuracy of the converter. A mismatch between R4 and R5 introduces a gain error. Overall gain is trimmed by adjusting RIN. The AD648’s low input offset voltage, low drift over temperature, and excellent dynamics make it an attractive low power output buffer.

The input offset voltage of the AD648 output amplifier results in an output error voltage. This error voltage equals the input offset voltage of the op amp times the noise gain of the amplifier.

That is:

$$V_{OS\ Output} = V_{OS\ Input} \left(1 + \frac{R_{FB}}{R_O} \right)$$

RFB is the feedback resistor for the op amp, which is internal to the DAC. RO is the DAC’s R-2R ladder output resistance. The value of RO is code dependent. This has the effect of changing the offset error voltage at the amplifier’s output. An output amplifier with a sub millivolt input offset voltage is needed to preserve the linearity of the DAC’s transfer function.

Figure 25. Sign Magnitude Code Table

The AD648 in this configuration provides a 700 kHz small signal bandwidth and 1.8 V/ μ s typical slew rate. The 33 pF capacitor across the feedback resistor optimizes the circuit's response. The oscilloscope photos in Figures 26a and 26b show small and large signal outputs of the circuit in Figure 24. Upper traces show the input signal V_{IN} . Lower traces are the resulting output voltage with the DAC's digital input set to all 1s. The circuit settles to $\pm 0.01\%$ for a 20 V input step in 14 μ s.

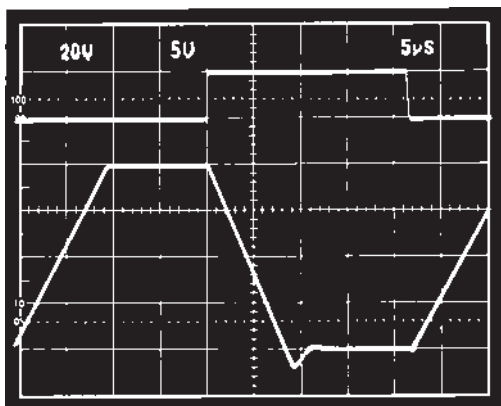


Figure 26a. Response to ± 20 V p-p Reference Square Wave

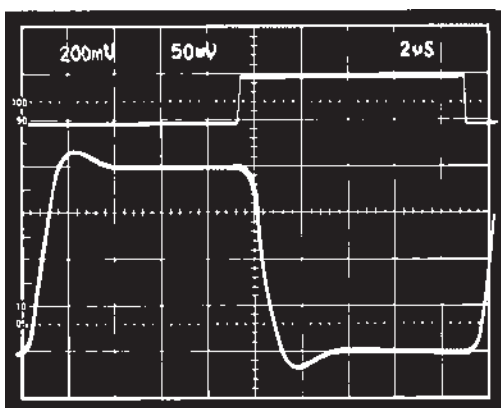


Figure 26b. Response to ± 100 mV p-p Reference Square Wave

DUAL PHOTODIODE PREAMP

The performance of the dual photodiode preamp shown in Figure 27 is enhanced by the AD648's low input current, input voltage offset, and offset voltage drift. Each photodiode sources a current proportional to the incident light power on its surface. R_F converts the photodiode current to an output voltage equal to $R_F \times I_S$.

An error budget illustrating the importance of low amplifier input current, voltage offset, and offset voltage drift to minimize output voltage errors can be developed by considering the equivalent circuit for the small (0.2 mm² area) photodiode shown in Figure 27. The input current results in an error proportional to the feedback resistance used. The amplifier's offset will produce an error proportional to the preamp's noise gain ($1 + R_F/R_{SH}$), where R_{SH} is the photodiode shunt resistance. The amplifier's input current will double with every 10°C rise in temperature, and the photodiode's shunt resistance halves with every 10°C rise. The error budget in Figure 28 assumes a room temperature photodiode R_{SH} of 500 M Ω , and the maximum input current and input offset voltage specs of an AD648C.

The capacitance at the amplifier's negative input (the sum of the photodiode's shunt capacitance, the op amp's differential input capacitance, stray capacitance due to wiring, etc.) will cause a rise in the preamp's noise gain over frequency. This can result in excess noise over the bandwidth of interest. C_F reduces the noise gain "peaking" at the expense of signal bandwidth.

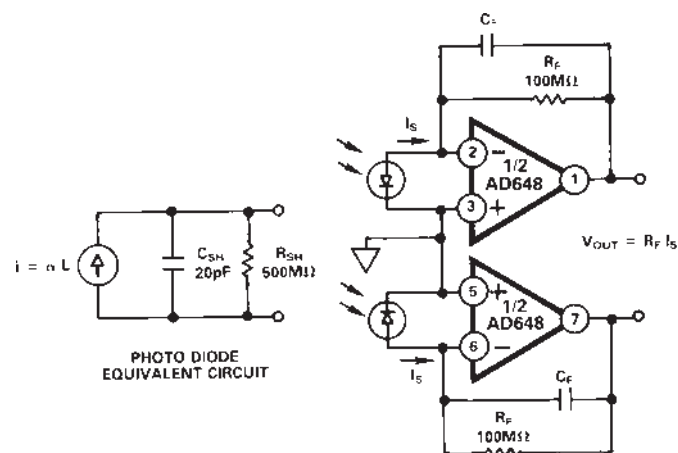


Figure 27. A Dual Photodiode Pre-Amp

TEMP °C	R_{SH} (M Ω)	V_{OS} (μ V)	$(1 + R_F/R_{SH}) V_{OS}$	I_B (pA)	$I_B R_F$	TOTAL
-25	15,970	150	151 μ V	0.30	30 μ V	181 μ V
0	2,830	225	233 μ V	2.26	262 μ V	495 μ V
+25	500	300	360 μ V	10.00	1.0 mV	1.36 mV
+50	88.5	375	800 μ V	56.6	5.6 mV	6.40 mV
+75	15.6	450	3.33 mV	320	32 mV	35.3 mV
+85	7.8	480	6.63 mV	640	64 mV	70.6 mV

Figure 28. Photodiode Pre-Amp Errors Over Temperature

AD648

INSTRUMENTATION AMPLIFIER

The AD648J's maximum input current of 20 pA per amplifier makes it an excellent building block for the high input impedance instrumentation amplifier shown in Figure 29. Total current drain for this circuit is under 600 μ A. This configuration is optimal for conditioning differential voltages from high impedance sources.

The overall gain of the circuit is controlled by R_G , resulting in the following transfer function:

$$\frac{V_{OUT}}{V_{IN}} = 1 + \frac{(R3 + R4)}{R_G}$$

Gains of 1 to 100 can be accommodated with gain nonlinearities of less than 0.01%. The maximum input current is 30 pA over

the common-mode range, with a common-mode impedance of over $1 \times 10^{12} \Omega$. The capacitors C1, C2, C3 and C4 compensate for peaking in the gain over frequency which is caused by input capacitance.

To calibrate this circuit, first adjust trimmer R1 for common-mode rejection with 10 V dc applied to the input pins. Next, adjust R2 for zero offset at V_{OUT} with both inputs grounded. Trim the circuit a second time for optimal performance.

The -3 dB small signal bandwidth for this low power instrumentation amplifier is 700 kHz for a gain of 1 and 10 kHz for a gain of 100. The typical output slew rate is 1.8 V/ μ s.

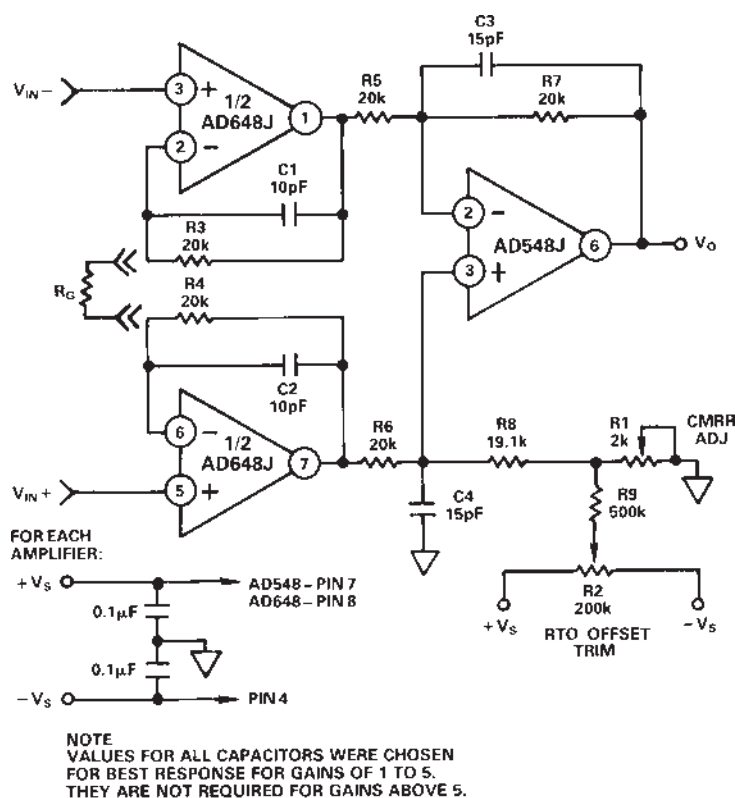


Figure 29. Low Power Instrumentation Amplifier

LOG RATIO AMPLIFIER

Log ratio amplifiers are useful for a variety of signal conditioning applications, such as linearizing exponential transducer outputs and compressing analog signals having a wide dynamic range. The AD648's picoamp level input current and low input offset voltage make it a good choice for the front end amplifier of the log ratio circuit shown in Figure 30. This circuit produces an output voltage equal to the log base 10 of the ratio of the input currents I_1 and I_2 . Resistive inputs R1 and R2 are provided for voltage inputs.

Input currents I_1 and I_2 set the collector currents of Q1 and Q2, a matched pair of logging transistors. Voltages at points A and B are developed according to the following familiar diode equation:

$$V_{BE} = (kT/q) \ln (I_C/I_{ES})$$

In this equation, k is Boltzmann's constant, T is absolute temperature, q is an electron charge, and I_{ES} is the reverse saturation current of the logging transistors. The difference of these two voltages is taken by the subtractor section and scaled by a factor of approximately 16 by resistors R9, R10, and R8. Temperature compensation is provided by resistors R8 and R15,

which have a positive 3500 ppm/°C temperature coefficient. The transfer function for the output voltage is:

$$V_{OUT} = 1 \text{ V} \log_{10} (I_2/I_1)$$

Frequency compensation is provided by R11, R12, C1, and C2. Small signal bandwidth is approximately 300 kHz at input currents above 100 μ A and will proportionally decrease with lower signal levels. D1, D2, R13, and R14 compensate for the effects of the two logging transistors' ohmic emitter resistance.

To trim this circuit, set the two input currents to 10 μ A and adjust V_{OUT} to zero by adjusting the potentiometer on A3. Then set I_2 to 1 μ A and adjust the scale factor such that the output voltage is 1 V by trimming potentiometer R10. Offset adjustment for A1 and A2 is provided to increase the accuracy of the voltage inputs.

This circuit ensures a 1% log conformance error over an input current range of 300 pA to 1 mA, with low level accuracy limited by the AD648's input current. The low level input voltage accuracy of this circuit is limited by the input offset voltage and drift of the AD648.

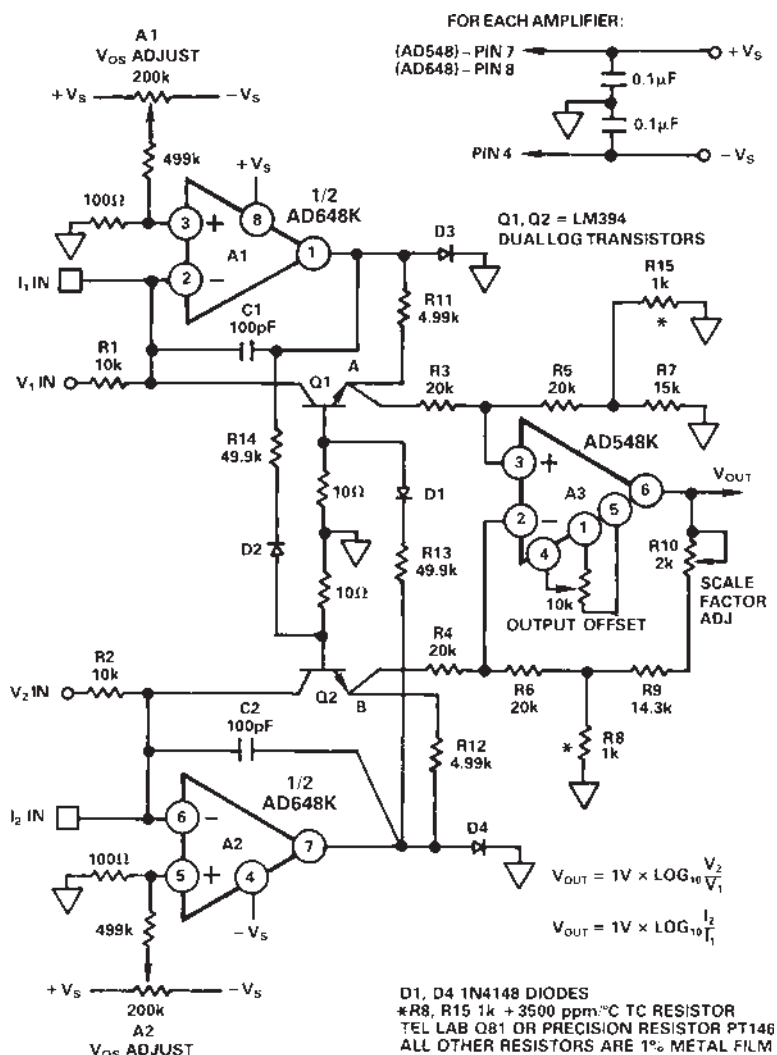
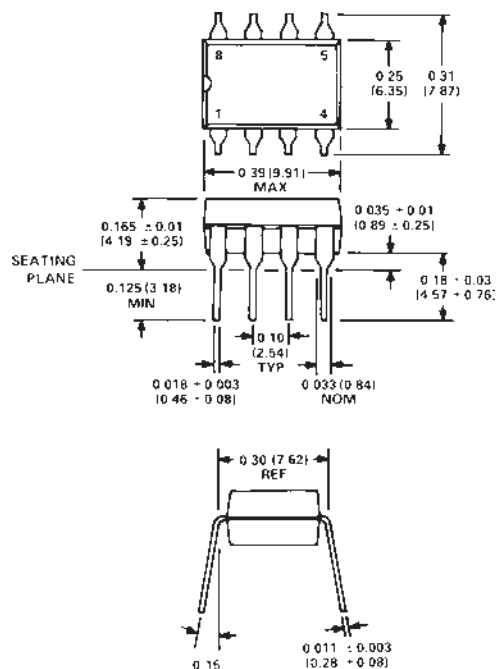


Figure 30. Precision Log Ratio Amplifier

OUTLINE DIMENSIONS

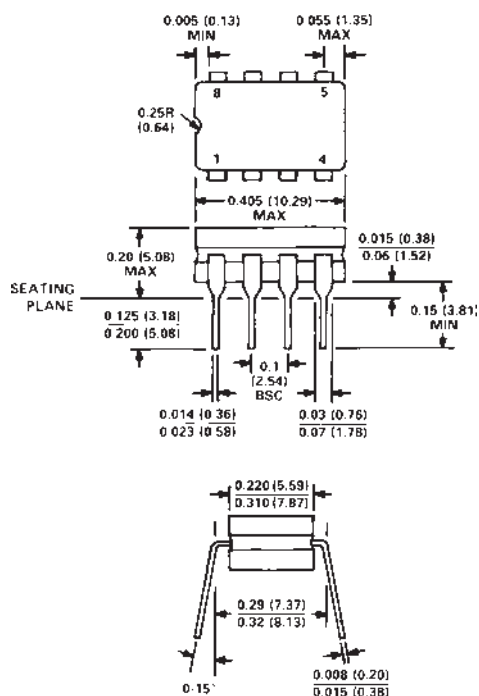
Mini-DIP (N) Package

Dimensions shown in inches and (millimeters)



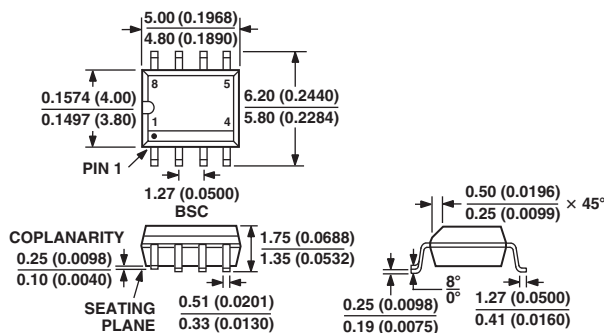
CERDIP (Q) Package

Dimensions shown in inches and (millimeters)



8-Lead SOIC (R) Package

Dimensions shown in millimeters and (inches)



CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

COMPLIANT TO JEDEC STANDARDS MS-012 AA

Revision History

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Change to SOIC (R-8) Package	12
Edits to FEATURES	1
Deleted Connection Diagram	1
Deleted AD648C column from SPECIFICATIONS	2
Deleted METALIZATION PHOTOGRAPH	3
Deleted Metal Can from Figure 22	6
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